MOS FET

FC4B21300L1

# **Panasonic**

### FC4B21300L1

### Gate resistor installed Dual N-channel MOS FET

For lithium-ion secondary battery protection circuits

#### ■ Features

- Source-source ON resistance:Rss(on) typ. = 80 mΩ(VGS = 3.8 V)
- CSP(Chip Size Package)
- RoHS compliant (EU RoHS / MSL:Level 1 compliant)

■ Marking Symbol: 29

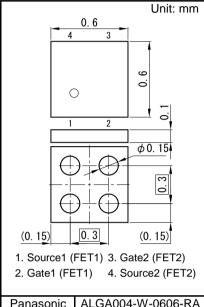
#### ■ Packaging

Embossed type (Thermo-compression sealing): 1 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Source-source Voltage	VSS	12	V
Gate-source Voltage	VGS	±8	V
Source Current (DC)	IS *1	1.5	Α
	IS *2	2	Α
Source Current (Pulsed)	ISp *3	15	Α
Total Power Dissipation	PD *1	0.32	W
	PD *2	0.6	W
Channel Temperature	Tch	150	°C
Storage Temperature Range	Tstg	-55 to +150	°C
Thermal Resistance (ch-a)	Rth *1	390	°C/W
	Rth *2	208	°C/W

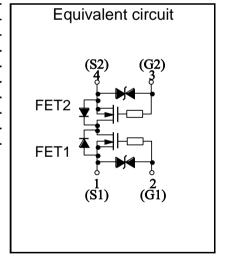
- Note \*1 Mounted on FR4 board (  $25.4~\text{mm} \times 25.4~\text{mm} \times t1.0~\text{mm}$  ) using the minimum recommended pad size ( $36\mu\text{m}$  Copper ).
  - \*2 Mounted on Ceramic substrate (70 mm  $\times$  70 mm  $\times$  t1.0 mm).



Panasonic ALGA004-W-0606-RA

JEITA —

Code —



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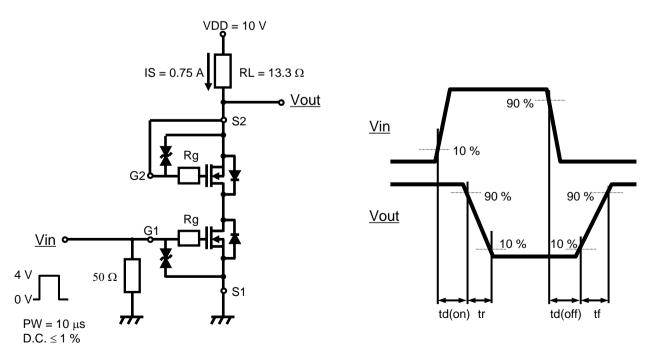
### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Source-source Breakdown Voltage	VSSS	IS = 1 mA, VGS = 0 V	12			V	
Zero Gate Voltage Source Current	ISSS	VSS = 12 V, VGS = 0 V			1.0	μΑ	
Gate-source Leakage Current	IGSS	$VGS = \pm 8 \text{ V}, VSS = 0 \text{ V}$			±10		
		$VGS = \pm 5 V$ , $VSS = 0 V$			±1.0	μΑ	
Gate-source Threshold Voltage	Vth	IS = 0.03  mA, VSS = 10  V	0.35	0.90	1.4	V	
Source-source On-state Resistance	RSS(on)1	IS = 0.75 A, VGS = 4.5 V	55	70	95	mΩ	
	RSS(on)2	IS = 0.75 A, VGS = 3.8 V	60	80	110		
	RSS(on)3	IS = 0.75 A, VGS = 3.1 V	65	90	150		
	RSS(on)4	IS = 0.75 A, VGS = 2.5 V	70	115	225		
Body Diode Forward Voltage	VF(s-s)	IF = 0.75 A, VGS = 0 V		0.6	1.2	V	
Input Capacitance *1	Ciss			115		pF	
Output Capacitance *1	Coss	VSS = 10 V, VGS = 0 V, f = 1 MHz		25			
Reverse Transfer Capacitance *1	Crss			18			
Turn-on delay Time *1,*2	td(on)	VDD = 10 V, VGS = 0 to 4.0 V		0.10		0	
Rise Time *1,*2	tr	IS = 0.75 A		0.20		μS	
Turn-off delay Time *1,*2	td(off)	VDD = 10 V, VGS = 4.0 to 0 V		0.27		μS	
Fall Time *1,*2	tf	IS = 0.75 A		0.22			
Total Gate Charge *1	Qg	VDD = 10 V		1.7			
Gate-source Charge *1	Qgs	VGS = 0  to  4.0  V,		0.5		nC	
Gate-drain Charge *1	Qgd	IS = 0.75 A		0.45			

Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors. Note

- \*1 Guaranteed by design, not subject to production testing
- \*2 Measurement circuit for Turn-on Delay Time / Rise Time / Turn-off Delay Time / Fall Time

Note2: Measurement circuit



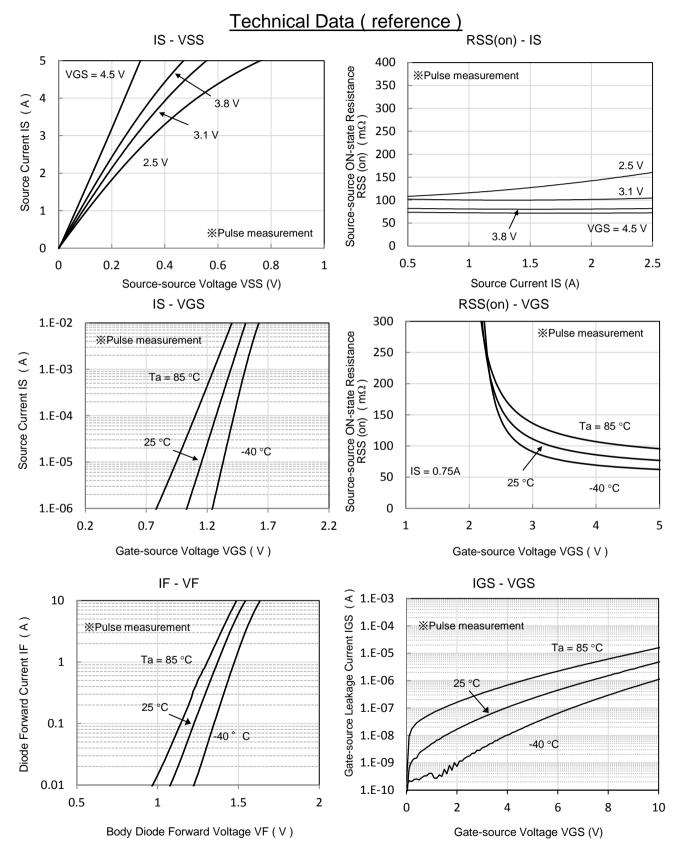
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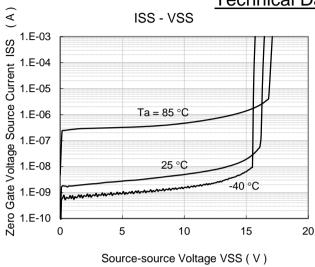
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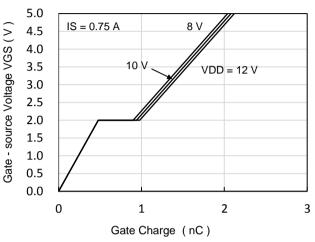
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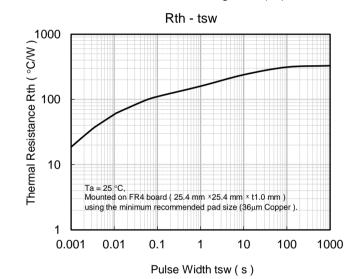
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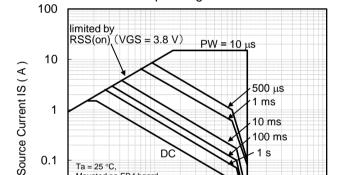




Dynamic Input/Output Characteristics





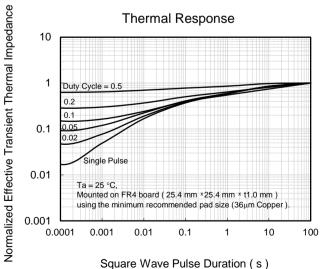


Ta = 25 °C, Mounted on FR4 board (25.4 mm ×25.4 mm × t1.0 mm) using the minimum recommended pad size (36µm Copper).

0.01

0.1

Safe Operating Area



Source-source Voltage VSS ( V )

10

100

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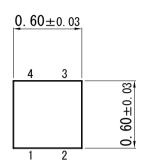
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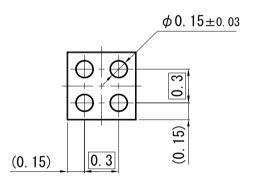
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■ Outline (ALGA004-W-0606-RA)

Unit: mm

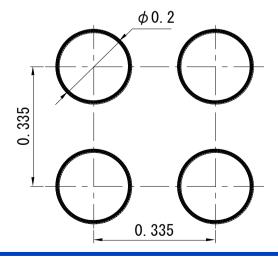






■ Land Pattern (Reference)

Unit: mm



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